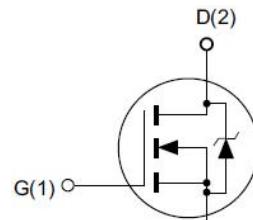
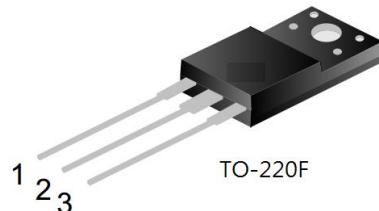


Features

- ◆ 500V, 13A, $R_{DS(ON)}$ (Max.) = 0.5Ω@ VGS = 10V.
- ◆ Fast Switching
- ◆ 100% Avalanche Tested


Application

- ◆ Adaptor
- ◆ Standby Power
- ◆ Switching power supply
- ◆ PFC


Absolute Maximum Ratings $T_c = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Limit		Unit
		TO-220F		
V_{DS}	Drain-Source Voltage ^a	500		V
V_{GS}	Gate-Source Voltage	± 30		V
I_D	Drain Current-Continuous, $T_c = 25^\circ\text{C}$	13		A
	Drain Current-Continuous, $T_c = 100^\circ\text{C}$	8.2		A
I_{DM}	Drain Current-Pulsed ^b	52		A
P_D	Maximum Power Dissipation @ $T_j = 25^\circ\text{C}$	42		W
EAS	Single Pulsed Avalanche Energy ^d	720		mJ
T_j, T_{STG}	Operating and Store Temperature Range	-55 to 150		°C

Thermal Characteristics

Symbol	Parameter	Value		Unit
$R_{\theta} J_C$	Thermal Resistance, Junction-Case _{Max}	2.98		°C/W

Electrical Characteristics $T_j = 25^\circ\text{C}$ unless otherwise noted
Off Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu\text{A}$	500	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 500V, V_{GS} = 0V$	-	-	1	μA
I_{GSS}	Forward Gate Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 30V$	-	-	± 100	nA

On Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2	-	4	V

R _{DS(on)}	Static Drain-Source On-Resistance ^c	V _{GS} = 10V, I _D = 6.5A	-	0.36	0.5	Ω
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■ Dynamic Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
C _{iss}	Input Capacitance	V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz	-	1995	-	pF
C _{oss}	Output Capacitance		-	203	-	pF
C _{rss}	Reverse Transfer Capacitance		-	9	-	pF

■ On Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
t _{d(on)}	Turn-On Delay Time	V _{DD} = 250V, I _D = 13A, V _{GS} = 10V	-	29	-	ns
t _r	Turn-On Rise Time		-	22	-	ns
t _{d(off)}	Turn-Off Delay Time		-	64	-	ns
t _f	Turn-Off Fall Time		-	33	-	ns
Q _g	Total Gate Charge	V _{DS} = 400V, I _D = 13A, V _{GS} = 10V	-	41	-	nC
Q _{gs}	Gate-Source Charge		-	9	-	nC
Q _{gd}	Gate-Drain Charge		-	13.2	-	nC

■ Drain-Source Diode Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
I _s	Drain-Source Diode Forward Continuous Current	V _{GS} = 0V	-	-	13	A
I _{SM}	Maximum Pulsed Current	V _{GS} = 0V	-	-	52	A
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0V, I _s = 13A	-		1.4	V

Notes:

- a. T_J=+25 °C to +150 °C
- b. Repetitive rating; pulse width limited by maximum junction temperature.
- c. Pulse width ≤ 300us; duty cycle ≤ 2%
- d. L = 10mH, I_{AS} = 12A

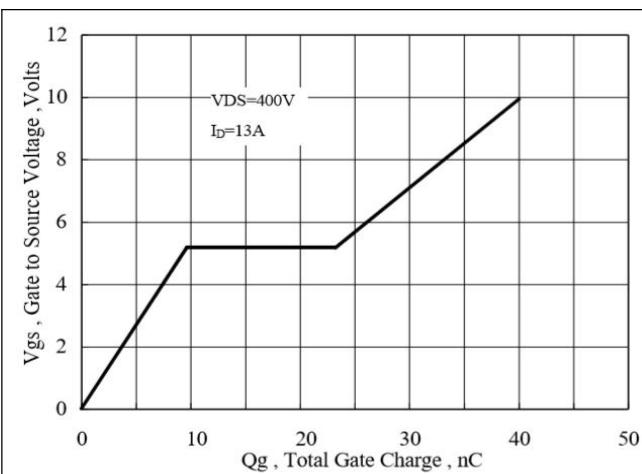


Figure 1. Gate Charge Characteristics

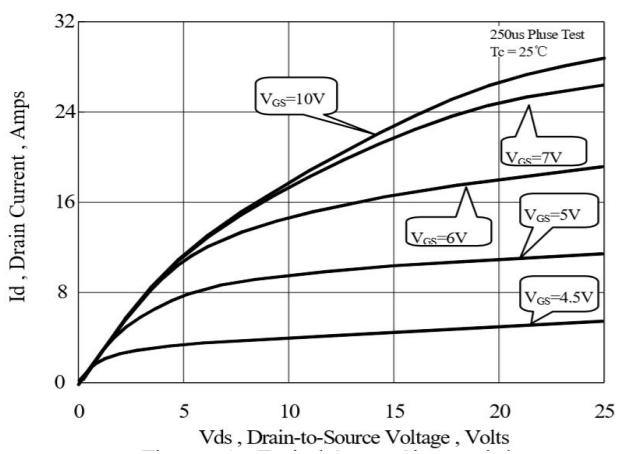


Figure 2. On-State Characteristics

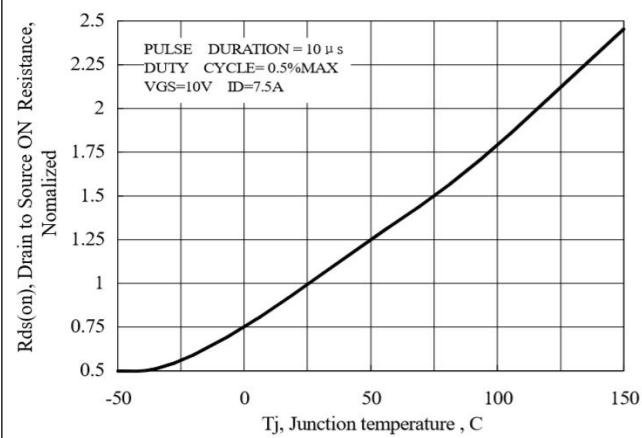


Figure 3. Normalized On-Resistance Variation with Temperature

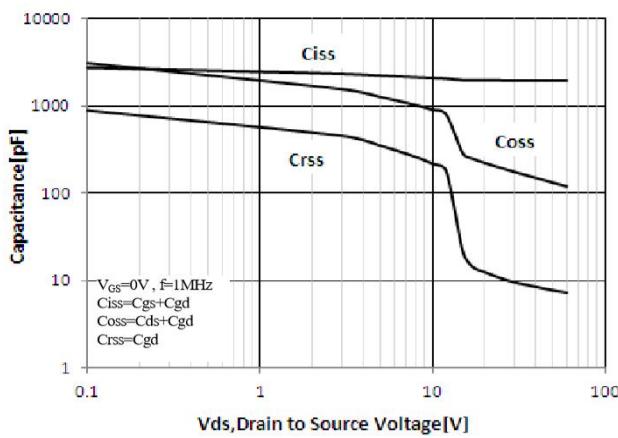


Figure 4. Typical Capacitance vs Drain to Source Voltage

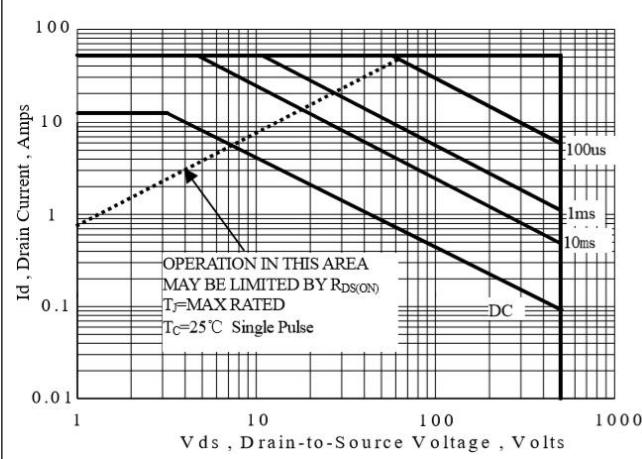


Figure 5 Maximum Forward Bias Safe OperatingArea
TO-220F

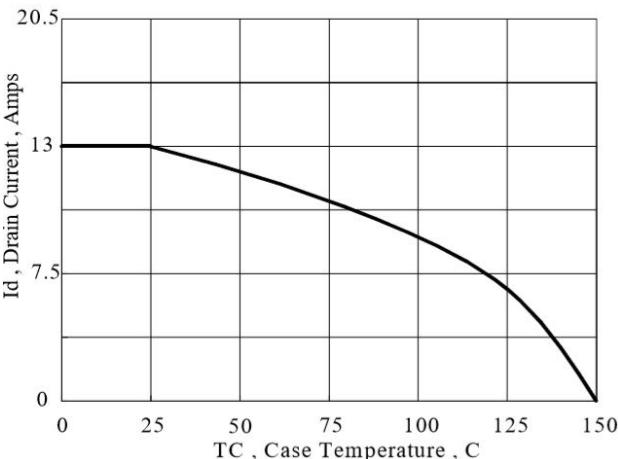


Figure 6. Maximum Continuous Drain Current vs Case Temperature